

VUTX002R870PA

Datasheet





VUTX002R870PA

General Description

V _{(BR)DSS}	R _{DS(ON)_max}	I_D
-20V	87mΩ@-4.5V	2.4
	147mΩ@-2.5V	-2A

Symbol

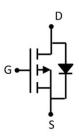


Figure 1 Symbol of VUTX002R870PA

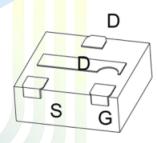
Features

- Advanced trench MOSFET process technology
- Ultra low on-resistance with low gate charge
- High power and current handing capability

Application

- PWM application
- Load switch for Portable Devices

Package Type



DFN1X1-3L

Figure 2 Package Type of VUTX002R870PA

Ordering Information

Product Name	Package
VUTX002R870PA	DFN1X1-3L



VUTX002R870PA

Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V _{DSS}	-20	V	
Gate-Source Voltage	V _{GSS}	±12	V	
Continuous Drain Current ^{Note1}	I_D	-2	Δ.	
Pulsed Drain Current Note2	I_{DM}	-10	A	
Total Power Dissipation ^{Note4}	P _D	0.2	W	
Junction Temperature	TJ	150	°C	
Storage Temperature	T _{STG}	-55 to 150	°C	

Thermal Resistance

Parameter	Symbol	Min	T <mark>yp</mark>	Max	Unit	
Thermal Resistance, Junction-to-CaseNote5	$R_{ heta JC}$		625		°C/W	





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Electrical Characteristics (T_A= 25 °C, unless otherwise specified)

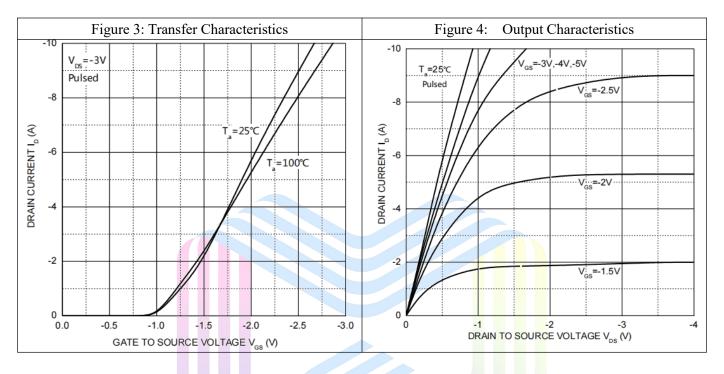
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	$\mathrm{BV}_{\mathrm{DSS}}$	$V_{GS}=0V, I_{D}=250uA$	-20			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = -20V, V_{GS} =0V			-1	uA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA
Gate Threshold Voltage ^{Note3}	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_D=-250uA$	-0.4	-0.7	-1	V
Static Drain-Source On-Resistance ^{Note3}	D	V_{GS} =-4.5V, I_{D} = -2A		67	87	mΩ
Static Drain-Source On-Resistance	$R_{\mathrm{DS(ON)}}$	V_{GS} =-2.5V, I_D = -1.8A		98	147	
Forward Transconductance ^{Note3}	gfs	V_{DS} =-5V, I_{D} = -2A	5			S
Dynamic Characteristics						
Input Capacitance	C _{ISS}	V _{DS} =-10V		290		pF
Output Capacitance	Coss	V _{GS} =0V		60		pF
Reverse Transfer Capacitance	C _{RSS}	f=1MHz		34		pF
Total Gate Charge	Qg	V _{DS} =-10V		3.0		
Gate-Source Charge	Q_{gs}	V _{GS} =-4.5V		0.5		nC
Gate-Drain Charge	Q_{gd}	$I_D = -2A$		0.8		
Switching Parameters						
Turn-on Delay Time	t _{d(on)}	$V_{DD} = -10V$		10		
Turn-on Rise Time	\mathbf{t}_{r}	V_{GS} = -4.5V		5.0		***
Turn-off Delay Time	$t_{\rm d(off)}$	$R_L=5\Omega$		21		ns
Turn-off Fall Time	t_{f}	$R_G=3\Omega$		7		
Diode Characteristics						
Diode Forward Voltage Note3	V_{SD}	$V_{GS}=0V, I_{S}=-2A$			-1.2	V
Continuous Source Current	I_{S}	$T_{\rm C}$ =25 °C			-2.0	A

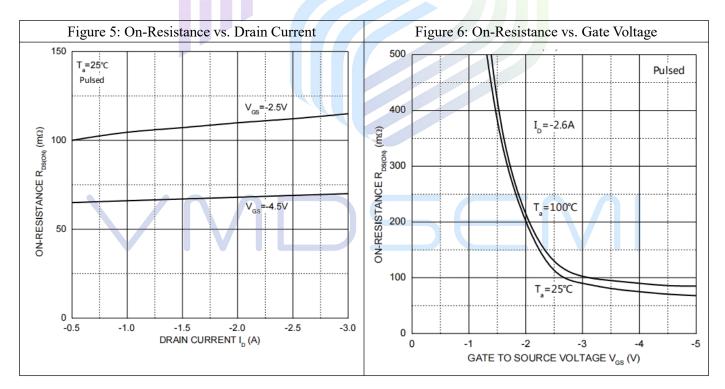
Notes:

- 1. The maximum current rating is limited by package. And device mounted on a large heatsink.
- 2. Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.
- 4. Pulse Test : Pulse Width $\leq 300 \mu s$, duty cycle $\leq 2\%$.
- 5. The power dissipation P_D is limited by $T_{J(MAX)} = 150^{\circ}C$. And device mounted on a large heatsink
- 6.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

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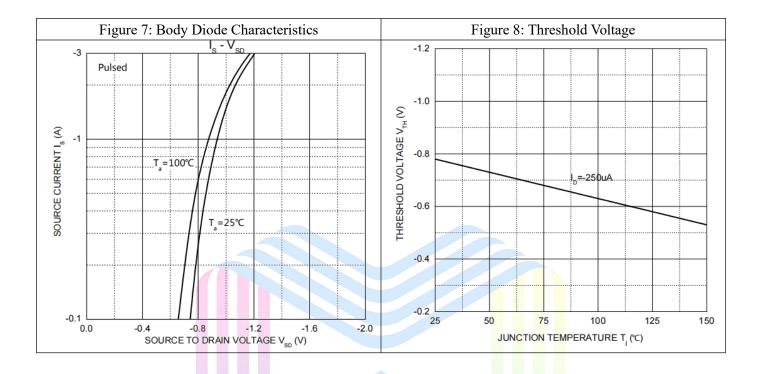
Typical Performance Characteristics







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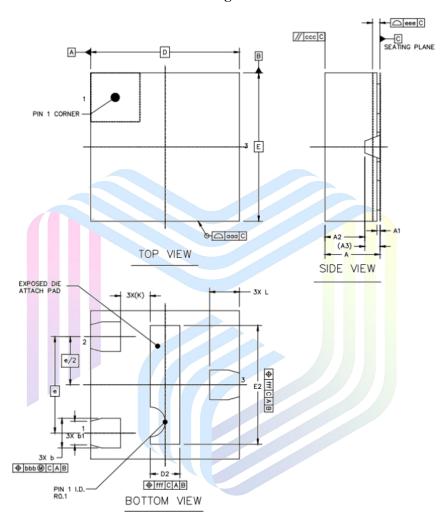






Mechanical Dimensions:

DFN1X1-3L Package Information



Cumbal	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	0.340	0.400	0.013	0.016	
A1	0.000	0.050	0.000	0.002	
A2	0.270	TYP	0.01	ITYP	
A3	0.102REF		0.004REF		
b	0.150	0.250	0.006	0.010	
b1	0.160	REF	0.006REF		
D	1.000	BSC	0.039BSC		
Е	1.000BSC		0.039BSC		
е	0.650	BSC	0.026BSC		
D2	0.100	0.300	0.004	0.012	
E2	0.700	0.900	0.028	0.035	
L	0.150	0.250	0.006	0.010	
K	0.200REF		0.008	BREF	
aaa	0.100TYP		0.004	4TYP	
ccc	0.100TYP		0.004TYP		
eee	0.050TYP		0.002	0.002TYP	
bbb	0.100TYP		0.004TYP		
fff	0.100)TYP	0.004TYP		



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